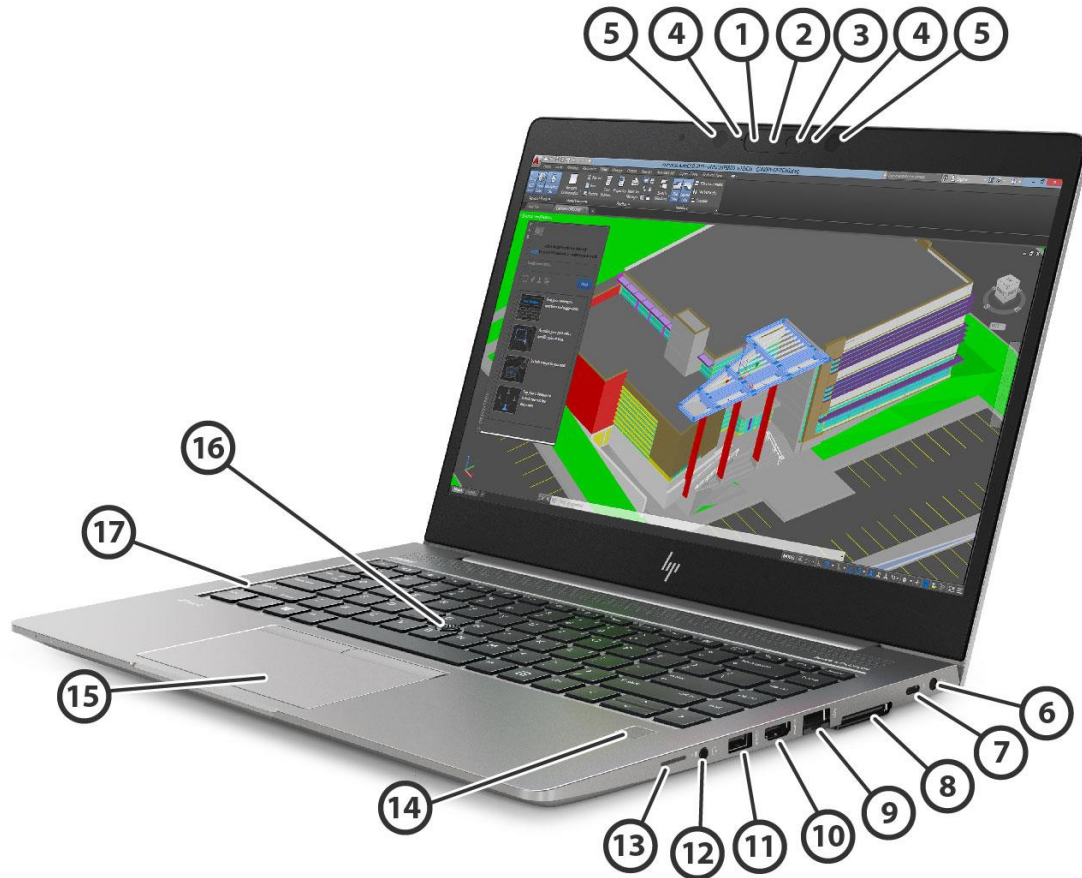


Overview

HP ZBook 14u G5 Mobile Workstation

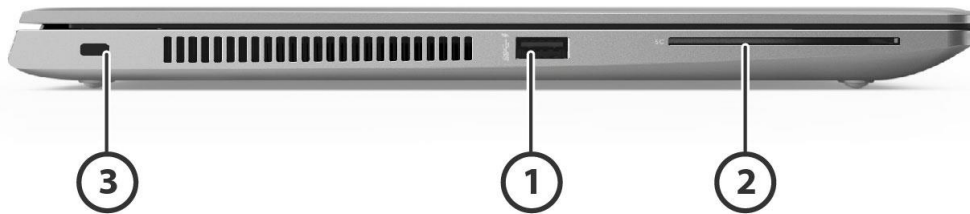


Front

- | | |
|--|------------------------------------|
| 1. HD Camera (Select models only) | 10. HDMI port (Cable not included) |
| 2. IR Camera (Select models only) | 11. USB 3.1 Gen 1 port |
| 3. Webcam LED (Select models only) | 12. Audio combo jack |
| 4. Internal microphones | 13. SIM card slot ¹ |
| 5. IR Camera LEDs (Select models only) | 14. Fingerprint sensor |
| 6. Power connector | 15. Clickpad |
| 7. USB Type-C™ with Thunderbolt™ | 16. Pointstick |
| 8. Docking connector | 17. HP Collaboration Keyboard |
| 9. Ethernet port | |

¹All units have a SIM card slot and icon but units that do not support WWAN are shipped with a non-removable SIM slot plug

Overview



Left

1. 1 USB 3.1 Gen1 port (charging)
2. 1 smart card reader
3. Security lock slot

Overview

At A Glance

- Eye-catching ultraslim design, premium precision-crafted machined aluminum (CNC), seamless formed aluminum chassis for clean, crisp, premium look and feel.
- Tested and passed 14 MIL-STD-810G tests*.
- Workstation-caliber AMD Radeon Pro™ discrete graphics: AMD Radeon Pro™ WX3100 (2 GB dedicated GDDR5); AMD Enduro™ graphics technology.
- Intel® Integrated graphics: Intel® HD Graphics 620 integrated on 7th Generation Intel Core processors. Intel® UHD Graphics 630 integrated on 8th Generation Intel Core processors.
- ISV certified to provide fast and reliable performance with workstation applications, including manipulation of 3D textures
- Choice of dual core 7th generation Intel® Core™ i7 and i5 or quad core 8th generation Intel® Core™ i7 and i5 processors
- Intel® Core™ i7 with vPro™ and Core™ i5 with vPro™ technology (optional)
- HP Performance Advisor for optimal configuration, compatibility and performance
- Up to two SODIMMs supporting up to 32 GB DDR4-2400 MHz dual channel memory.
- Supports up to 3 independent displays via internal LCD Panel, system DisplayPort™, system VGA, or using the HP UltraSlim Docking Station or HP Thunderbolt Docking Station. Supports DisplayPort™ 1.2 monitors.
- Featuring HP Collaboration Keyboard with Clickpad to manage most commonly used conferencing functions with a single keystroke. HP Spill Resistant Collaboration Keyboard with Durakeys with Duracoat finish. Backlight keyboard in full aluminum deck with magnesium bottom reinforcement, chemically strengthened glass clickpad, and updated system functions indicators. One touch access: Wireless On/Off, Volume Mute
- HP tuned Bang and Olufsen audio optimized for high fidelity audio with immersive surround sound with deep, rich bass and crystal-clear dialog without distortion at high volume, and new discrete amp.
- Up to 14 hours of battery life using an HP Long life battery solution: 3-cell (50 WHr) supporting HP Fast Charge Technology
- 14-inch diagonal LED-backlit display:
 - FHD IPS eDP anti-glare, 67% sRGB at 220 nits (1920x1080)
 - FHD IPS eDP + PSR anti-glare, 100% sRGB at 400 nits with ambient light sensor (1920x1080)
 - UHD IPS eDP + PSR anti-glare, 100% sRGB at 400 nits with ambient light sensor (3840x 2160)
 - FHD IPS eDP touch screen with Corning Gorilla Glass 3, 67% sRGB at 220 nits (1920x1080)
 - HP SureView Integrated Privacy Display FHD IPS eDP + PSR anti-glare, 100% sRGB at 300-700 nits with ambient light sensor (1920x1080)
 - HP SureView Integrated Privacy Display FHD IPS eDP + PSR touch screen with Corning Gorilla Glass 3, 100% sRGB at 700 nits (1920x1080)
- Wireless connectivity options:
 - Intel® Dual Band Wireless-AC 8265 802.11 AC (2x2) WiFi and Bluetooth 4.2 combo adaptor (vPro™)
 - Intel® Dual Band Wireless-AC 8265 802.11 AC (2x2) WiFi and Bluetooth 4.2 combo adaptor (non-vPro™)
 - Realtek RTL8822BE 802.11ac 2x2 Wi-Fi and Bluetooth 4.2 combo adapter
 - Optional integrated wireless 4G (LTE) mobile broadband module support
- One dedicated drive slots. (1) M.2 slot support up to 2 TB of storage
- Enterprise grade security with HP SureStart Gen4, HP Privacy Camera3, HP Sure View2, HP Sure Run, HP Sure Recover, and Fingerprint sensor
- Low halogen, ENERGY STAR® certified and EPEAT® Gold registered in the U.S. EPEAT® status varies by country- please see epeat.net.

* MIL STD 810G testing is pending and is not intended to demonstrate fitness for U.S. Department of Defense contract requirements or for military use. Test results are not a guarantee of future performance under these test conditions. Accidental damage requires an optional HP Accidental Damage Protection Care Pack.

NOTE: See important legal disclosures for all listed specs in their respective features sections.

Features

OPERATING SYSTEM

Preinstalled OS	Windows 10 Pro 64* Windows 10 Home 64 Plus* FreeDOS 2.0
Supported OS	Windows 10 Enterprise 64*

* Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows 10 is automatically updated, which is always enabled. ISP fees may apply and additional requirements may apply over time for updates. See <http://www.windows.com>

NOTE: Your product does not support Windows 8 or Windows 7
In accordance with Microsoft's support policy, HP does not support the Windows® 8 or Windows 7 operating system on products configured with Intel and AMD 7th generation and forward processors or provide any Windows® 8 or Windows 7 drivers on <http://www.support.hp.com>

PROCESSOR*

- 7th Generation Intel® Core™ i5-7200U with Intel® HD Graphics 620 (2.5 GHz base frequency, up to 3.1 GHz with Intel® Turbo Boost Technology, 3 MB cache, 2 cores)
- 7th Generation Intel® Core™ i5-7300U with Intel® HD Graphics 620 (2.6 GHz base frequency, up to 3.5 GHz with Intel® Turbo Boost Technology, 3 MB cache, 2 cores)
- 7th Generation Intel® Core™ i7-7500U with Intel® HD Graphics 620 (2.7 GHz base frequency, up to 3.5 GHz with Intel® Turbo Boost Technology, 4 MB cache, 2 cores)
- 7th Generation Intel® Core™ i7-7600U with Intel® HD Graphics 620 (2.8 GHz base frequency, up to 3.9 GHz with Intel® Turbo Boost Technology, 4 MB cache, 2 cores)
- 8th Generation Intel® Core™ i5-8250U with Intel® UHD Graphics 620 (1.6 GHz base frequency, up to 3.4 GHz with Intel® Turbo Boost Technology, 6 MB cache, 4 cores)
- 8th Generation Intel® Core™ i5-8350U with Intel® UHD Graphics 620 (1.7 GHz base frequency, up to 3.6 GHz with Intel® Turbo Boost Technology, 6 MB cache, 4 cores)
- 8th Generation Intel® Core™ i7-8550U with Intel® UHD Graphics 620 (1.8 GHz base frequency, up to 4.0 GHz with Intel® Turbo Boost Technology, 8 MB cache, 4 cores)
- 8th Generation Intel® Core™ i7-8650U with Intel® UHD Graphics 620 (1.9 GHz base frequency, up to 4.2 GHz with Intel® Turbo Boost Technology, 8 MB cache, 4 cores)

* Multi-Core is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. Intel's numbering, branding and/or naming is not a measurement of higher performance.

Also note that the Intel® Turbo Boost is based on max GHz for a single core.

Features

CHIPSET

Intel® Kaby Lake Chipset integrated with 7th Generation processor
Intel® Kaby Lake – R Chipset integrated with 8th Generation processor

INTEL® CORE™ I5 WITH VPRO/CORE I7 WITH VPRO TECHNOLOGY CAPABLE

Intel® Core™ i5 with vPro™ and Core™ i7 with vPro™ technology is a selectable feature that is available on units configured with select processors, a qualified Intel® WLAN module and a preinstalled Windows operating system. It provides advances in remote manageability, security, energy efficient performance, and wireless connectivity. Intel Active Management Technology (iAMT) offers built-in manageability and proactive security for networked mobile workstations, even when they are powered off* or when the operating system is inoperable. It can help identify threats before they reach the network, isolate infected systems, and update mobile workstations regardless of their power state.

* Requires a Windows operating system, network hardware and software, connection with a power source, and a direct (non-VPN) corporate network connection which is either cable or wireless LAN.

NOTE: Some functionality of Intel® Core™ i5 with vPro™/Core™ i7 with vPro™ technology, such as Intel Active Management technology and Intel Virtualization technology, requires additional third- party software in order to run. Availability of future "virtual appliances" applications for Intel® Core™ i5 with vPro™/Core™ i7 with vPro™ technology is dependent on third- party software providers. Compatibility with future "virtual appliances" is yet to be determined.

GRAPHICS

Intel® HD 620 Graphics*
Intel® UHD 630 Graphics**
AMD Radeon Pro™ WX3100 (2 GB dedicated GDDR5) ***
Microsoft DirectX® 12 (Shader Model 5.0) and OpenGL® 4.3capable
AMD Enduro™ Technology supported.

* HD content required to view HD images; only available on 7th Generation Intel® processors

** UHD content required to view UHD images; only available on 8th Generation Intel® processors

*** Supports up to 3 independent displays via internal LCD Panel, system HDMI 1.4, or using the HP UltraSlim Docking Station DisplayPort™ and VGA ports (sold separately).

DISPLAY

- **Internal**
 - 14.0" diagonal FHD IPS eDP anti-glare, 67% sRGB at 220 nits (1920x1080)
 - 14.0" diagonal FHD IPS eDP + PSR anti-glare, 100% sRGB at 400 nits with ambient light sensor (1920x1080)
 - 14.0" diagonal UHD IPS eDP + PSR anti-glare, 100% sRGB at 400 nits with ambient light sensor (3840x 2160)
 - 14.0" diagonal FHD IPS eDP touch screen with Corning Gorilla Glass 3, 67% sRGB at 220 nits (1920x1080)
 - HP SureView Integrated Privacy Display 14.0" diagonal FHD IPS eDP + PSR anti-glare, 100% sRGB at 300-700 nits with ambient light sensor Touch (1920x1080)
 - HP SureView Integrated Privacy Display 14.0" diagonal FHD IPS eDP + PSR touch screen with Corning Gorilla Glass 3, 100% sRGB at 700 nits (1920x1080)

Features

External

Up to 30-bit (2³⁰) per pixel "Deep Color"
(total of 1,073,741,824 color variations)

HDMI 1.4b

Supports resolution up to 4k @ 24 Hz

Without HP Thunderbolt Dock G2:

HP ZBook 14u with hybrid graphics and without the use of a dock supports up to a maximum of three independent displays. These three displays are the internal panel plus two external displays connected two of the three following ports: HDMI 1.4, Thunderbolt™ 3, Thunderbolt™ 3. HP ZBook 14u configuration with Intel® integrated graphics and without the use of a dock supports up to a maximum of three independent displays. Any three-display combination of the system panel plus 2 of the following HDMI, Thunderbolt™ 3, Thunderbolt™ 3.

With HP UltraSlim Dock G2:

Supports up to 2 independent displays when docked on the HP UltraSlim Dock - Max. resolution = 2.5K @ 60Hz (DP1) & 2.5K @ 60Hz (DP2)11

With HP Thunderbolt Dock G2:

The HP Thunderbolt Dock G2 has Thunderbolt™ 3 port, VGA, two DisplayPort™ 1.3, and a USB-C port. When used together with the HP ZBook 14u configuration with hybrid graphics, a maximum of three independent displays are supported. These three displays are internal panel and two external displays connected to the ZBook dock's Thunderbolt™ 3, VGA, or two DisplayPort™ ports. When used together with the HP ZBook 14u configuration with Intel® integrated graphics, a maximum of three independent displays are supported. Any three display combination of the system panel, system ports and ZBook Dock ports. Max. resolution = 4K @60Hz (DP1) & 4K @60Hz (DP2) with Thunderbolt

NOTE: Resolutions are dependent upon monitor capability, and resolution and color depth settings.

Features

STORAGE AND DRIVES

One (1) dedicated M.2 drive slots, supporting up to 2 TB of storage

M.2 SATA Solid State Drive

128 GB SATA Solid State Drive

512 GB SATA TLCFIPS-140-2 Solid State Drive

HP Z Turbo Drive (NVMe PCIe SSD)

256 GB PCIe (NVMe) TLC Solid State Drive

512 GB PCIe (NVMe) TLC Solid State Drive

1 TB PCIe (NVMe) TLC Solid State Drive

2 TB PCIe (NVMe) TLC Solid State Drive

256 GB PCIe (NVMe) TLC Self Encrypting (SED) Solid State Drive

512 GB PCIe (NVMe) TLC Self Encrypting (SED) Solid State Drive

256 GB PCIe (NVMe) MLC Solid State Drive

512 GB PCIe (NVMe) MLC Solid State Drive

1 TB PCIe (NVMe) MLC Solid State Drive

* For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to up to 30 GB (for Windows 10) disk is reserved for system recovery software.

DRIVE CONTROLLERS

M.2 Storage Bay (SATA):

SATA-3 for Solid State Drive

HP Z Turbo Drive:

PCIe Gen 3 x 4 lanes NVMe Solid State Drive

RAID:

Not supported

MEMORY

Standard

Up to 32 GB DDR4 Non ECC SDRAM

Transfer rates up to 2133MT/s on Intel Kaby Lake Chipset or Transfer rates up to 2400MT/s on Intel Kaby Lake – R Chipset

Two SODIMM slots supporting dual-channel memory

4 GB, 8GB and 16 GB SODIMMs

Maximum

Upgradeable to 32768 MB with optional 16384 MB SODIMMs in 2 slots

Dual-channel

Maximized dual-channel performance requires SODIMMs of the same size and speed in both memory channels.

* Maximum memory capacities assume Windows 64-bit operating systems or Linux. With Windows 32-bit operating systems, memory above 3 GB may not all be available due to system resource requirements.

NOTE: Due to the non-industry standard nature of some third-party memory modules, we recommend HP branded memory to ensure compatibility. If you mix memory speeds, the system will perform at the lower memory speed.

Features

NETWORKING/COMMUNICATIONS

Communications

Intel® I219-LM Gigabit* Network Connection (vPro configurations)

Intel® I219-V Gigabit* Network Connection (non-vPro configurations)

* The term "10/100/1000" or "Gigabit" Ethernet indicates compatibility with IEEE standard 802.3ab for Gigabit Ethernet, and does not connote actual operating speed of 1 Gb/s. For high-speed transmission, connection to a Gigabit Ethernet server and network infrastructure is required.

Wireless

Secure, integrated wireless LAN and wireless WAN options featuring support for the latest industry standards. Broadband Wireless (WWAN) requires a Windows operating system and is available in select countries as a standard, factory configurable feature only. Integrated Bluetooth is also available (factory configurable only) combined with the supported wireless LAN option.

802.11 Wireless LAN*

Intel® Dual Band Wireless-AC 8265 802.11 ac (2x2) WiFi + Bluetooth 4.2 Combo Adaptor* (vPro)

Intel® Dual Band Wireless-AC 8265 802.11 ac (2x2) WiFi + Bluetooth 4.2 Combo Adaptor* (non-vPro)

Realtek RTL8822BE 802.11 ac (2x2) WiFi + Bluetooth 4.2 Combo Adapter*

Wireless WAN - Mobile Broadband **

Intel XMM 7360 LTE-Advanced Broadband Module (optional)

HP It4132, LTE/HSPA+ 4G Mobile Broadband Module (optional)

Miracast***

Native Miracast Support

Near Field Communications (NFC)

NXP NPC300 Near Field Communication Module (optional)

* Wireless cards are optional or add-on features and requires separately purchased wireless access point and internet service. Availability of public wireless access points limited. The specifications for the 802.11ac WLAN are draft specifications and are not final. If the final specifications differ from the draft specifications, it may affect the ability of the notebook to communicate with other 802.11ac WLAN devices.

** WWAN use requires separately purchased service contract. Check with service provider for coverage and availability in your area. Connection speeds will vary due to location, environment, network conditions, and other factors. 4G LTE not available on all products, and in all regions.

*** Miracast is a wireless technology your PC can use to project your screen to TVs, projectors, and streaming

AUDIO/MULTIMEDIA

Audio

Audio custom tuned by HP and Bang and Olufsen audio

Integrated stereo speakers

Integrated HP World Facing Microphone (dual-microphone array when equipped with optional webcam)

Button for volume mute; function keys for volume up and down

Combo mic-in / stereo headphone-out jack

Webcam

720 HD webcam

Features

720 HD webcam with infrared imaging (IR) – (optional)

- Microsoft Hello Certification: Microsoft face authentication in Windows 10 is an enterprise-grade identity verification mechanism
- Microsoft Skype for Business1 Certified
- HD format (widescreen 16:9)
- Supports videoconferencing and still image capture
- High quality fixed focus lens
- Video capture at various resolutions up to 1280x720 resolution (720p) and up to 30fps
- M-JPEG compression supports higher frame rates for video capture and videoconferencing
- Improved low light sensitivity
- Improved dynamic range

HP Privacy Camera Shutter (only available on non-touch configurations)

* [HD content required to view HD images.](#)

Features

KEYBOARDS/POINTING DEVICES/BUTTONS & FUNCTION KEYS

Keyboard

Optional backlit HP Collaboration Keyboard with Function key control to toggle backlit brightness setting - off/full/half brightness. The HP spill-resistant keyboard is designed using a thin layer of Mylar film under the keyboard and a drain system that funnels fluid through a hole in the bottom of the notebook. This minimizes the risk of damage to sensitive components underneath. The 86-key compatible keyboard features a full-pitch key layout with desktop keyboard features, such as editing keys, both left and right control and alt keys, function keys, and 18.7 x 18.4 mm key pitch (center-to-center spacing). U.S. and International key layouts are available. Other features include hot keys for instant access to power conservation and brightness.

Pointing Devices

Clickpad with multi-touch gestures enabled, taps enabled as default
Microsoft Precision Touchpad Default Gestures Support
Dual Point Stick

Function Keys

Function keys provide control of the following features: standby mode, external display, volume down, volume up, and display brightness.

- F1 - Display Switching
- F2 - Blank or SureView
- F3 - Brightness Down
- F4 - Brightness Up
- F5 - Audio Mute
- F6 - Volume Down
- F7 - Volume Up
- F8 - Mic Mute
- F9 - Blank or Backlit Toggle
- F10 - NumLk
- F11 - Wireless
- F12 - Calendar
- >Share/Present
- >Call Answer
- >Call End

Hidden Functions

- Fn+R = Break
- Fn+S = Sys Rq
- Fn+C = Scroll Lock

SOFTWARE AND SECURITY

Preinstalled Software

BIOS

- HP BIOSphere Gen4¹
- HP DriveLock | HP Automatic DriveLock
- BIOS Update via Network
- Master Boot Record Security
- Power On Authentication
- Secure Erase²
- Absolute Persistence Module³
- Pre-boot Authentication
- HP Wireless Wakeup

Features

Communication / Connectivity

HP Mobile Connect Pro⁴
Native Miracast Support⁵
HP LAN-WLAN Protection
HP Connection Optimizer
HP MAC Address Manager (select models only)
HP Wireless Wakeup (select models only)
HP SureConnect
HP Noise Cancellation Software

HP Value Add Software

HP 3D DriveGuard 6
HP ePrint Driver + JetAdvantage⁶
HP Hotkey Support
HP Recovery Manager
HP Jumpstart
HP Support Assistant¹¹
HP Performance Advisor
HP Remote Graphics Software

Microsoft Products

Buy Office
Bing Search
Skype⁷

Manageability

HP Driver Packs⁸
HP SoftPaq Download Manager (SDM)
HP System Software Manager (SSM)⁸
HP BIOS Config Utility (BCU)⁸
HP Client Catalog⁸
HP Manageability Integration Kit Gen 2 for Microsoft SCCM⁹
Ivanti Management Suite¹⁶
HP Image Assistant
LANDESK Management¹⁰

For more information on HP Client Management Solutions refer to: <http://www.hp.com/go/clientmanagement>.

Client Security Software

- HP Client Security Suite Gen4¹²
- HP Security Manager¹⁷ (including Credential Manager Password Manager and HP Spare Key)
- HP Fingerprint Sensor¹⁹
- Power On Authentication
- Device Access Manager
- Microsoft Defender¹³

Security Management

HP BIOSphere Gen4¹⁴
HP DriveLock & Automatic DriveLock
BIOS Update via Network
Secure Erase¹⁵
Pre-boot Authentication
TPM 2.0 Embedded Security Chip shipped with Windows 10 (Common Criteria EAL4+ Certified)²⁰

Features

SATA 0,1 port disablement (viaBIOS)
RAID configurations²⁰
Serial, USB enable/disable (viaBIOS)
Power-on password (viaBIOS)
Setup password (viaBIOS)
Support for chassis padlocks and cable lock devices
HP Sure Click²¹
HP Sure Start Gen4¹⁸
HP Sure Run²²
HP Sure Recover²³

TPM

Model: Infineon SLB9670
Version: 7.62.3126.0
Revision: TPM 2.0
FIPS 140-2 Compliant: Yes (select models only)

Smartcard Reader

Model number: Alcor AU9560

FIPS 201 Compliant: Yes

IPv6 Certification: Yes

MD5 Hash: Please follow the instructions below to access MD5 Hash.

Log-on to <http://hp.com/support>, enter your product name, select software and drivers, select OS, select driver. After selecting the driver, click on “Associated files” and then click on “Download”. When opening the file, under “Purpose” you should see the appropriate “SOFTPAQ MD5:” Field

Is the BIOS on this notebook ISO/IEC 19678:2015 (formerly NIST 800-147) compliant?: Yes

UEFI version: 2.5

For more information on HP Client Security Software Suite, refer to <http://www.hp.com/go/clientsecurity>.

1. Requires Intel® 7th generation processors or greater
2. For the methods outlined in the National Institute of Standards and Technology Special Publication 800-88. Supported on Elite and Z platforms with BIOS version F.03 or higher
3. Absolute agent is shipped turned off, and will be activated when customers activate a purchased subscription. Subscriptions can be purchased for terms ranging multiple years. Service is limited, check with Absolute for availability outside the U.S. The Absolute Recovery Guarantee is a limited warranty. Certain conditions apply. For full details visit: <http://www.absolute.com/company/legal/agreements/> computrace-agreement. Data Delete is an optional service provided by Absolute Software. If utilized, the Recovery Guarantee is null and void. In order to use the Data Delete service, customers must first sign a Pre-Authorization Agreement and either obtain a PIN or purchase one or more RSA SecurID tokens from Absolute Software.
4. HP Mobile Connect Pro is only available on preconfigured devices with WWAN. For geographic availability refer to <http://www.hp.com/go/mobileconnect>
5. Miracast is a wireless technology your PC can use to project your screen to TVs, projectors, and streaming media players that also support Miracast. You can use Miracast to share what you're doing on your PC and present a slide show. For more information: <http://windows.microsoft.com/en-us/windows-8/project-wireless-screen-miracast>
6. Requires an Internet connection to HP web-enabled printer and HP ePrint account registration (for a list of eligible printers, supported documents and image types and other HP ePrint details, see <http://www.hp.com/go/eprintcenter>). Separately purchased data plans or usage fees may apply. Print times and connection speeds may vary.
7. Skype is not offered in China.
8. Not preinstalled, however available for download at <http://www.hp.com/go/clientmanagement>
9. HP Manageability Integration Kit can be downloaded from <http://www8.hp.com/us/en/ads/clientmanagement/overview.html>
10. Subscription required.
11. Requires Windows and Internet Access
12. HP Client Security Suite Gen4 requires Windows and Intel® or AMD 8th generation processors.
13. Opt in and internet connection required for updates.
14. HP BIOSphere Gen4 features may vary depending on the PC platform and configurations requires 8th Gen Intel® processors.
15. Secure Erase for the methods outlined in the National Institute of Standards and Technology Special Publication 800-88.

Features

Supported on Elite platforms with BIOS version F.03 or higher.

16. Ivanti Management Suite subscription required.

17. HP Password Manager requires Internet Explorer or Chrome or FireFox. Some websites and applications may not be supported. User may need to enable or allow the add-on / extension in the internet browser.

18. HP Sure Start Gen4 is available on HP EliteBook products equipped with Intel® 8th generation processors

19. HP Fingerprint Sensor sold separately or as an optional feature.

20. RAID configuration is optional and does require a second hard drive.

21. HP Sure Click is available on select HP platforms and supports Microsoft® Internet Explorer and Chromium™. Check

<http://h20195.www2.hp.com/v2/GetDocument.aspx?docname=4AA7-0922ENW> for all compatible platforms as they become available.

22. HP Sure Run is available on HP Elite products equipped with Intel® or AMD® 8th generation processors

23. HP Sure Recover is available on HP Elite PCs with 8th generation Intel® or AMD processors and requires an open, wired network connection. You must back up important files, data, photos, videos, etc. before using HP Sure Recover to avoid loss of data

Workstation ISV Certifications

Find the latest list of certifications at: <http://www.hp.com/go/isv>

HP Remote Graphics Software

The remote desktop solution for serious workstation users and their most demanding applications.

Download at: <http://www.hp.com/go/RGS>

HP Performance Advisor

Get the most out of your HP Workstation on day one—and every day thereafter. Designed for all users regardless of technical background, this ultra-savvy software wizard is the simplest and most effective way to make sure your computer is always operating at its optimum potential.

Download at: <http://www.hp.com/go/performanceadvisor>

Security

See Software section above.

Other Standard Security Features

Integrated Smart Card Reader One-Step Logon

Security lock slot

Support for Intel® AT

Optional Security Features

HP Fingerprint Sensor (optional)

Absolute Data Protect* with GPS Tracking - Subscription based security solution providing the ability to track, initiate physical recovery, conduct asset management, and perform remote data delete by utilizing GPS technology. GPS functionality requires HP Mobile Broadband Module.

* The Absolute Data Protect agent is shipped turned off, and must be activated by customers when they purchase a subscription. Subscriptions can be purchased for terms ranging multiple years. Service is limited, check with Absolute for availability outside the U.S.

HP CENTRAL MANAGEMENT

HP offers a variety of scalable hardware, software, and BIOS-based security features to help you defend your organization against viruses and other threats. These integrated security features safeguard what matters to you the most - your data, device and identity. Now, be confident your fleet of devices is protected in multiple layers of HP Client Security protection.

HP BIOS Protection keeps you up and running with enhanced protection against virus attacks and other threats. And if the BIOS is accidentally compromised, the auto recovery feature automatically restores it to its fully functional state.

Features

HP Sure Start detects and negates a BIOS attack with automatic recovery of the BIOS even when the installation is accidentally compromised (i.e. power outage). When HP Sure Start heals the BIOS an event log is generated that an IT administrator can retrieve so the business is aware of a BIOS attack. Golden copy of BIOS is stored in protected nonvolatile memory providing redundant, hardware-based protection against a new generation of attacks.

An optional fingerprint reader and integrated Smart Card Reader help keep your identity secure. The security cable slot helps keep your notebook physically secure.

You can even permanently destroy data on your hard drive in preparation for your system disposal or redeployment with Secure Erase.

Features

POWER

Power Supply

HP Smart 45 W External AC power adapter⁴²

HP Smart 45 W External AC power adapter, 2-prong (Japan only)⁴² HP Smart 65 W External AC power adapter⁴²

HP Smart 65 W EM External AC power adapter⁴²

45 W USB Type-C™ adapter⁴²

65 W USB Type-C™ adapter⁴²

HP 65W Slim Smart AC Adapter

Primary Battery

HP Long Life 3-cell Lithium Polymer Battery (50 WHr) supporting HP Fast Charge Technology

Power Cord

2-wire plug - 1.0m (Japan only)⁴²

3-wire plug - 1.0m⁴²

3-wire plug - 1.8m⁴²

Duckhead power cord - 1.0m⁴²

Duckhead power cord - 1.8m⁴²

Battery Life

Battery life up to 14 hours *

NOTE: Battery is internal and not replaceable by the customer

System Standby Time

Up to 1 weeks**

*Battery life will vary depending on the product model, configuration, loaded applications, features, use, wireless functionality and power management settings. The maximum capacity of the battery will naturally decrease with time and usage. See MobileMark14 battery benchmark <https://bapco.com/products/mobilemark-2014/> for additional details.

** Standby life will vary depending on various factors including battery, Memory, CPU, EC and LAN chip. The maximum capacity of the battery will naturally decrease with time and usage.

Power Conservation

AMD® Polaris™ Technology

Hibernation

Standby

ACPI compliance

ENVIRONMENTAL

US ENERGY STAR®

IT ECO declaration

EPEAT®Gold; EPEAT® registered where applicable. EPEAT® registration varies by country. See <http://www.epeat.net> for registration status by country. See HP's 3rd party option store for solar energy accessory www.hp.com/go/options.

NOTE: This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks.

Features

WEIGHTS & DIMENSIONS

Weight

Starting at 3.27 lb (non-touch); Starting at 3.56 lb (touch)⁴⁵
Starting at 1.48 kg (non-touch); Starting at 1.61 kg (touch)⁴⁵

Dimensions (w x d x h)

Non-touch

12.84 x 9.22 x 0.7 in
32.6 x 23.4 x 1.79 cm

Touch

12.22 x 9.03 x 0.71 in
32.6 x 23.4 x 1.81 cm

NOTE: Height varies depending upon where on the notebook the measurement is made. Weight varies by configuration and components. Weight includes non-touch panel, 3 cell 50Whr battery, without hard drive and with 256 GB Z Turbo Drive (PCIe SSD).

PORTS/SLOTS

Ports

Left side:

- (1) USB 3.1 Charging Port
- (1) Security lock slot

Right side:

- (1) Thunderbolt 3™
- (1) USB 3.1 Port
- (1) Headphone/Microphone Combo
- (1) RJ-45 / Ethernet
- (1) Side Docking connector
- (1) Power connector
- (1) SIM Card Slot

Digital Media Slots

- (1) Integrated Smart Card Reader (Compatible with ISO 7816 compliant Smart Cards PC/SC interface support)

SERVICE AND SUPPORT

Limited 3-year or 1-year limited warranty options available, depending on country. Batteries have the same 1-year or 3-year limited warranty as the platform. 24/7 operation will not void the HP warranty. Optional¹ HP Care Pack Services are extended service contracts which go beyond your standard limited warranties. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at <http://www.hp.com/go/cpc>.

1. Sold separately or as an optional feature. Service levels and response times for HP Care Packs may vary depending on your geographic location. Service starts on date of hardware purchase. Restrictions and limitations apply. HP services are governed by the applicable HP terms and conditions of service provided or indicated to Customer at the time of purchase. Customer may have additional statutory rights according to applicable local laws, and such rights are not in any way affected by the HP terms and conditions of service or the HP Limited Warranty provided with your HP Product. Consult your local HP Customer Support Center for details.

Technical Specifications – System Unit

SYSTEM UNIT

Stand-Alone Power Requirements (AC Power)	Nominal Operating Voltage	19.5 V dc @ 3.3 A
	Average Operating Power	Windows® 10 (64-bit) AMD FirePro™ Graphics
Temperature	Max Operating Power	< 45 W with UMA < 65 W with discrete
	Operating	32° to 95° F (0° to 35° C) (not writing optical) 41° to 95° F (5° to 35° C) (writing optical)
Relative Humidity	Non-operating	-4° to 140° F (-20° to 60° C)
	Operating	10% to 90%, non-condensing
Shock	Non-operating	5% to 95%, 101.6° F (38.7° C) maximum wet bulb temperature
	Operating	40 G, 2 ms, half-sine
Random Vibration	Non-operating	200 G, 2 ms, half-sine
	Operating	0.75 grms
Altitude (unpressurized)	Non-operating	1.50 grms
	Operating	-50 to 10,000 ft. (-15.24 to 3,048 m)
Planned Industry Standard Certifications	Non-operating	-50 to 15,000 ft. (-15.24 to 12,192 m)
	UL	Yes
	CSA	Yes
	FCC Compliance	Yes
	ENERGY STAR®	Select models*
	EPEAT®	Gold**
	ICES	Yes
	Australia / NZ A-Tick Compliance	Yes
	CCC	Yes
	Japan VCCI Compliance	Yes
	KCC	Yes
	BSMI	Yes
	CE Marking Compliance	Yes
	MIL STD***	Passed 14 Mil STD Tests

* Configurations of the HP ZBook 14u G5 that are ENERGY STAR® certified are identified as HP ZBook 14u G5 ENERGY STAR® on HP websites and on <http://www.energystar.gov>.

** EPEAT registration varies by country. See <http://www.epeat.net> for registration status by country.

EPEAT status listed above applies to U.S.

*** MIL STD 810G testing is pending and is not intended to demonstrate fitness for U.S. Department of Defense contract requirements or for military use. Test results are not a guarantee of future performance under these test conditions. Damage under the MIL STD test conditions or any accidental damage requires an optional HP Accidental Damage Protection Care Pack.

For accessibility information on HP products, please visit: <http://www.hp.com/accessibility>.

Technical Specifications – Displays

DISPLAYS

**14.0" diagonal LED AG
backlight FHD IPS eDP
(1920 x 1080) (220 nits)
67% sRGB**

Outline Dimensions (W x H)	316.112 x 197.98 max.	
Active Area	309.312 x 173.988(mm)	
Weight	<280g max.	
Diagonal Size	14.0 - inch	
Thickness	3.0mm max	
Interface	eDP 1.2	
Panel Technology	IPS	
Surface Treatment	Anti-glare	
Touch enabled	No	
Contrast Ratio	600:1 (typical)	
Refresh Rate	60 Hz	
Brightness	220 nits typical (panel only)	
Pixel Resolution	Format	1920 x 1080 (FHD)
	Configuration	RGB
Backlight	LED	
Color Gamut Coverage	67% sRGB	
Color Depth	6 bits + Hi FRC	
PPI	157	
Viewing Angle	UWVA 85/85/85/85	

DISPLAYS

**14.0" diagonal LED AG
backlight FHD IPS eDP
(1920 x 1080) (220 nits)
67% sRGB**

Outline Dimensions (W x H)	316.112 x 197.98 max.	
Active Area	309.312 x 173.988(mm)	
Weight	<280g max.	
Diagonal Size	14.0 - inch	
Thickness	3.0mm max	
Interface	eDP 1.2	
Panel Technology	IPS	
Surface Treatment	Anti-glare	
Touch enabled	No	
Contrast Ratio	600:1 (typical)	
Refresh Rate	60 Hz	
Brightness	220 nits typical (panel only)	
Pixel Resolution	Format	1920 x 1080 (FHD)
	Configuration	RGB
Backlight	LED	
Color Gamut Coverage	67% sRGB	
Color Depth	6 bits + Hi FRC	
PPI	157	
Viewing Angle	UWVA 85/85/85/85	

Technical Specifications – Displays

14.0" diagonal LED AG backlight FHD eDP + PSR (1920 x 1080) (400 nits) 100% sRGB	Outline Dimensions (W x H)	316.11 x 197.98 (mm) max.		
	Active Area	309.31 x 173.99 (mm)		
	Weight	<285g max.		
	Diagonal Size	14.0 (inch)		
	Thickness	3.0mm max.		
	Interface	eDP 1.3 + PSR (2 lane)		
	Panel Technology	IPS		
	Surface Treatment	Anti-Glare (AG)		
	Touch enabled	No		
	Contrast Ratio	600:1 (typical)		
	Refresh Rate	60 Hz		
	Brightness	400 nits typical (panel only)		
	Pixel Resolution	Format	1920 x 1080 (FHD)	
		Configuration	RGB	
	Backlight	LED		
	Color Gamut Coverage	100% sRGB		
	Color Depth	6 bits + Hi FRC		
	PPI	157		
	Viewing Angle	UWVA 85/85/85/85		

14.0" diagonal LED AG backlight UHD eDP + PSR (3840 x 2160) (400 nits) 100% sRGB	Outline Dimensions (W x H)	315.31 x 199.54 (mm) max.		
	Active Area	309.31 x 173.99 (mm)		
	Weight	<240 max.		
	Diagonal Size	14.0 (inch)		
	Thickness	2.4mm max		
	Interface	eDP 1.3 + PSR (4 lanes)		
	Panel Technology	IPS		
	Surface Treatment	Anti-Glare (AG)		
	Touch Enabled	No		
	Contrast Ratio	1200:1 (typical) - AG		
	Refresh Rate	60 Hz		
	Brightness	Format	3840 x 2160 (UHD)	
		Configuration	RGB	
	Backlight	LED		
	Color Gamut Coverage	100% sRGB		
	Color Depth	8 bits		
	PPI	157		
	Viewing Angle	UWVA 85/85/85/85		

14.0" diagonal LED backlight FHD IPS eDP	Outline Dimensions (W x H)	315.31 x 199.54 (mm) max.	
	Active Area	309.31 x 173.99 (mm)	

Technical Specifications – Displays

touch screen with Corning Gorilla Glass 3 (1920 x 1080) (220 nits) 67% sRGB

Weight	<240 max.
Diagonal Size	14.0 (inch)
Thickness	2.4mm max
Interface	eDP 1.3 + PSR (4 lanes)
Panel Technology	IPS
Surface Treatment	Anti-Glare (AG)
Touch enabled	No
Contrast Ratio	1200:1 (typical) - AG
Refresh Rate	60 Hz
Brightness	220 nits typical (panel only)
Pixel Resolution	Format 1920 x 1080 (FHD) Configuration RGB
Backlight	LED
Color Gamut Coverage	67% sRGB
Color Depth	6 bits + Hi FRC
PPI	157
Viewing Angle	UWVA 85/85/85/85

HP SureView Integrated Privacy Display 14.0" diagonal LED backlight FHD IPS Touch Screen with Corning Gorilla Glass 3 eDP + PSR (1920 x 1080) (700 nits) 100% sRGB

Active Area	309.31 x 173.99 (mm)
Weight	<225g max.
Diagonal Size	14.0 – inch
Thickness	3.0mm max.
Interface	eDP 1.4a + PSR (2 lane)
Panel Technology	IPS
Surface Treatment	Corning Gorilla Glass 3
Touch enabled	Yes
Contrast Ratio	"Privacy mode 150:1 (typ.) – Privacy, 110:1(min.)- Privacy
Refresh Rate	120 Hz
Brightness	700 nits typical (panel only)
Pixel Resolution	Format 1920 x 1080 (FHD) Configuration RGB
Backlight	LED
Color Gamut Coverage	100% sRGB
Color Depth	6 bits + Hi FRC
PPI	157
Viewing Angle	Privacy mode CR>2: UWVA 50/50/85/85

HP SureView Integrated Privacy Display 14.0" diagonal LED backlight

Outline Dimensions (W x H)	315.41x 196.14 (mm) max.
Active Area	309.31 x 173.99 (mm)

Technical Specifications – Displays

FHD IPS Anti-Glare, eDP + PSR (1920 x 1080) (700 nits) 100% sRGB	Weight	<225g max.
	Diagonal Size	14.0 – inch
	Thickness	3.0mm max.
	Interface	eDP 1.4a + PSR (2 lane)
	Panel Technology	IPS
	Surface Treatment	Anti-Glare
	Touch enabled	No
	Contrast Ratio	"Privacy mode 150:1 (typ.) – Privacy, 110:1(min.)- Privacy
	Refresh Rate	120 Hz
	Brightness	700 nits typical (panel only)
	Pixel Resolution	Format 1920 x 1080 (FHD)
		Configuration RGB
	Backlight	LED
	Color Gamut Coverage	100% sRGB
	Color Depth	6 bits + Hi FRC
	PPI	157
	Viewing Angle	Privacy mode CR>2: UWVA 50/50/85/85

Technical Specifications – Storage

STORAGE AND DRIVES*

128 GB M.2 SATA TLC Solid State Drive	Drive Weight	0.02 lb (10g)	
	Capacity	128 GB	
	Height	0.09 in (2.3mm)	
	Width	0.87 in (22mm)	
	Interface	ATA-8, SATA 3.0	
	NAND Type	TLC	
	Form Factor I/O	M.2 2280	
	Performance	Maximum Sequential Read	Maximum Sequential Write
		Up to 520 MB/s	Up to 450 MB/s
	Logical Blocks	250,069,680	
Operating Temperature	32 to 158F (0 to 70C) [ambient temp]		
Features	DIPM; TRIM; DEVSLP		

HP Z Turbo Drive 512 GB, M.2 SATA TLC FIPS Solid State Drive	Drive Weight	0.02 lb (10 g)	
	Capacity	512 GB	
	Height	0.09 in (2.3 mm)	
	Width	0.87 in (22 mm)	
	Generation		
	NAND Type	TLC	
	Form-Factor (I/O)	M.2 2280	
	Interface	ACS-3, SATA 3.2	
	Performance	Maximum Sequential Read	Maximum Sequential Write
		Up to 530 MB/s	Up to 400 MB/s
Logical Blocks	1,000,215,216		
Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]		
Features	ATA Security; TCG Opal 2.0; FIPS; DIPM; TRIM; DEVSLP		

HP Z Turbo Drive 1 TB M.2 NVMe MLC Solid State Drive	Drive Weight	0.02 lb (10 g)	
	Capacity	1024 GB	
	Height	0.09 in (2.3 mm)	
	Width	0.87 in (22 mm)	
	NAND Type	MLC	
	Form-Factor (I/O)	M.2 2280	
	Interface	PCIe NVMe Gen3X4	
	Drive Weight	0.02 lb (10 g)	
	Performance	Maximum Sequential Read	Maximum Sequential Write
		Up to 3,000 MB/s	Up to 2,900 MB/s
Logical Blocks	2,000,409,264		
Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]		
Features	ATA Security (Option), TRIM; L1.2		
Drive Weight	0.022 lb (10 g)		
Capacity	512 GB		

Technical Specifications – Storage

HP Z Turbo Drive 512 GB, M.2 NVMe MLC Solid State Drive	Height	0.09 in (2.3 mm)	
	Width	0.87 in (22 mm)	
	NAND Type	MLC	
	Form-Factor (I/O)	M.2 2280	
	Interface	PCIe NVMe Gen3X4	
	Performance	Maximum Sequential Read	Maximum Sequential Write
		Up to 3000 MB/s	Up to 1500MB/s
	Logical Blocks	1,000,215,216	
	Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]	
	Features	ATA Security (option), TRIM; L1.2	
HP Z Turbo Drive 256 GB, M.2 NVMe MLC Solid State Drive	Drive Weight	0.02 lb (10 g)	
	Capacity	256 GB	
	Height	0.09 in (2.23 mm)	
	Width	0.87 in (22 mm)	
	NAND Type	MLC	
	Form-Factor (I/O)	M.2 2280	
	Interface	PCIe NVMe Gen3X4	
	Performance	Maximum Sequential Read	Maximum Sequential Write
		Up to 3,100 MB/s	Up to 1,400 MB/s
	Logical Blocks	500,118,192	
Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]		
Features	ATA Security (Option); TRIM; L1.2		
HP Z Turbo Drive 2 TB, M.2 NVMe TLC Solid State Drive	Drive Weight	0.02 lb (10 g)	
	Capacity	2 TB	
	Height	0.09 in (2.3 mm)	
	Width	0.87 in (22 mm)	
	NAND Type	TLC	
	Form-Factor (I/O)	M.2 2280	
	Interface	PCIe NVMe Gen3X4	
	Performance	Maximum Sequential Read	Maximum Sequential Write
		2,900 MB/s	2,100 MB/s
	Logical Blocks	3,907,029,168	
Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]		
Features	ATA Security; DIPM; TRIM; DEVSLP		
HP Z Turbo Drive 1 TB, M.2 NVMe TLC Solid State Drive	Drive Weight	0.02 lb (10g)	
	Capacity	1 TB	
	Height	0.09 in (2.3mm)	
	Width	0.87 in (22mm)	
	NAND Type	TLC	
	Form-Factor (I/O)	M.2 2280	
	Interface	PCIe NVMe Gen3X4	
	Performance	Maximum Sequential Read	Maximum Sequential Write
		Up to 2800 MB/s	Up to 1600 MB/s
	Logical Blocks	2,000,409,264	

Technical Specifications – Storage

	Operating Temperature	32 to 158F (0 to 70C) [ambient temp]		
	Features	TRIM; L1.2		
HP Z Turbo Drive 512 GB, M.2 NVMe TLC Solid State Drive	Drive Weight	0.02 lb (10g)		
	Capacity	512 GB		
	Height	0.09 in (2.3mm)		
	Width	0.87 in (22mm)		
	NAND Type	TLC		
	Form-Factor (I/O)	M.2 2280		
	Interface	PCIe NVMe Gen3X4		
	Performance	Maximum Sequential Read	Maximum Sequential Write	
		Up to 2600 MB/s	Up to 1400 MB/s	
		Logical Blocks	1,000,215,216	
	Operating Temperature	32 to 158F (0 to 70C) [ambient temp]		
	Features	TRIM; L1.2		
HP Z Turbo Drive 256 GB, M.2 NVMe TLC Solid State Drive	Drive Weight	0.02 lb (10 g)		
	Capacity	256 GB		
	Height	0.09 in (2.3 mm)		
	Width	0.87 in (22 mm)		
	NAND Type	TLC		
	Form-Factor (I/O)	M.2 2280		
	Interface	PCIe NVMe Gen3X4		
	Performance	Maximum Sequential Read	Maximum Sequential Write	
		Up to 2,600 MB/s	Up to 900 MB/s	
		Logical Blocks	500,118,192	
	Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]		
	Features	ATA Security (Option); TRIM; L1.2		
HP Z Turbo Drive 512 GB, M.2 NVMe Self-Encrypting TLC Solid State Drive	Drive Weight	0.02 lb (10 g)		
	Capacity	512 GB		
	Height	0.09 in (2.3 mm)		
	Width	0.87 in (22 mm)		
	NAND Type	TLC		
	Form-Factor (I/O)	M.2 2280		
	Interface	PCIe NVMe Gen3X4		
	Performance	Maximum Sequential Read	Maximum Sequential Write	
		Up to 2,600 MB/s	Up to 1,400 MB/s	
		Logical Blocks	1,000,215,216	
	Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]		
	Features	ATA Security (Option); TRIM; OPAL 2; L1.2		
HP Z Turbo Drive 256 GB, M.2 NVMe Self-Encrypting TLC Solid State Drive	Drive Weight	0.02 lb (<10g)		
	Capacity	256 GB		
	Height	0.14 in (3.58mm)- 0.09 in (2.23mm)		
	Width	0.87 in (22mm)		
	NAND Type	TLC		
	Form-Factor (I/O)	M.2 2280		

Technical Specifications – Storage

Interface	PCIe NVMe Gen3X4	
Performance	Maximum Sequential Read	Maximum Sequential Write
	Up to 530 MB/s	Up to 515 MB/s
Logical Blocks	500,118,192	
Operating Temperature	32 to 158F (0 to 70C) [ambient temp]	
Features	ATA Security (Option); TRIM; OPAL 2; L1.2	

* For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to up to 30 GB (for Windows 10) disk is reserved for system recovery software.

Technical Specifications – Security

SECURITY

HP Fingerprint Sensor	Voltage	3.0-3.6V
	Operating temperature	14° - 167°F (-10° - 75°C)
	Current consumption image	36mA
	Low latency wait for finger	950 uA
	Capture rate	3000 lines/sec
	ESD Resistance	IEC 6100-4-2 4B (+/-15KV)
	Detection Matrix	200*1 (plus another secondary line); 508 dpi, sensor area 12*3 mm
Smart Card Reader	Smart card standard	PC/SC 2.0 for Windows smart card standard
	Dimensions (L x W x H)	0.41x 0.08 x 0.32 in (10.5 x 2 x 8.2 mm)
	Smart Card support	ISO 7816 Class A and AB smart cards
	Smart Card Interface	Smart Card Interface with T = 0 and T = 1 support Support I2C memory card, SLE4418, SLE4428, SLE4432, SLE4442, SLE4436, SLE5536, SLE6636, AT88SC1608, AT45D041 card and AT45DB041 card via external EEPROM
	Operating systems	Normal Mode With card present, before being suspended: 40.9 mA Without card present, before being suspended: 33.16 mA After being suspended with smart card present: 380 µA After being suspended without smart card present: 380 µA
	Features	<p>Power Saving Mode : With card present, before being suspended: 40.6 mA Without card present: 380 µA After being suspended with smart card present: 380 µA</p> <ul style="list-style-type: none"> • Support single slot • Support T0, T1 protocol • Support I2C memory card, SLE4418, SLE4428, SLE4432, SLE4442, SLE4436, • SLE5536, SLE6636, AT88SC1608, AT45D041 card and AT45DB041 card via external EEPROM • Support ISO7816 Class A, B and C (5V/3V/1.8V) card • Implemented as an USB full speed device with bulk transfer endpoint, Mass • Storage endpoint • Built-in PLL for USB and Smart Card clocks requirement • Support EEPROM for USB descriptors customization (PID/VID/iManufacturer/iProduct/Serial Number), Direct Web Page Link, and accessing memory card module. • EEPROM programmable via USB interface • Support software update for memory card module • Support Direct Web Page Link via configuration in external EEPROM • Support short APDU and extended APDU • Compatible with Microsoft USB-CCID driver • Support remote wake up through inserting card/removing card • Support USB selective suspend • Support Power Saving Mode (Using one pin to select between Normal/PWR Saving Mode) • Support card power over current protection mechanism • Built in resonator. • Support USB LPM (Link Power Management) features. • Embedded clock source.

Technical Specifications – Networking

NETWORKING/COMMUNICATION

Intel® I219-LM Gigabit Network Connection (vPro configurations)

Ethernet Features

10 Mbit/s operation (10BASE-T; IEEE 802.3i; IEEE 802.3 clauses 13-14)
100 10 Mbit/s operation (10BASE-T; IEEE 802.3i; IEEE 802.3 clauses 13-14)
100 Mbit/s operation (100BASE-TX; IEEE 802.3u; IEEE 802.3 clauses 21-30)
1000 Mbit/s operation (1000BASE-T; IEEE 802.3ab; IEEE 802.3. Clauses 40)
Auto-Negotiation (Automatic Speed Selection)
Full Duplex Operation at all Speeds, Half Duplex operation at 10 and 100 Mbit/s
IEEE 802.1p QoS (Quality of Service) Support
IEEE 802.1q VLAN support
IEEE 802.3x Flow Control (IEEE 802.3 clauses 31-32; configurable)
IEEE 802.3az EEE(Energy Efficient Ethernet)
Jumbo Frame 9K
Auto MDI/MDIX Crossover cable detection

Power Management Performance Features

ACPI compliant - multiple power modes
Energy Detect Low Power Mode(Green Ethernet)
TCP/IP/UDP Checksum Offload (configurable)
Protocol Offload(ARP & NS)
Large send offload and Giant send offload
Receiving Side Scaling
MACSec Offload (802.3ae)

Manageability

Intel® vPro
iSCSI Boot
RSS is kernel based support (e.g. in Win Server 2013)
Ultra Low Power at cable disconnect (<1mW) enables platform support for connected standby.
Wake-on-LAN from standby and hibernation (Magic Packet and Microsoft Wake-Up Frame); Wake-on-LAN from off (Magic Packet only)
PXE 2.1 Remote Boot
Statistics Gathering (SNMP MIB II, Ethernet-like MIB, Ethernet MIB (802.3x, clause 30))
Comprehensive diagnostic and configuration software suite
Virtual Cable Doctor for Ethernet cable status

Interface

PCI Express 1.1 x1 to fully support ASPM L0s/L1 and CLKREQ.
NOTE: Intel® I219-LM Gigabit interface is not PCIe compliant. It operates at half of PCIe specification V1.1 (2.5GT/S) speed.

NIC Device Driver Name

Intel® Ethernet Network Connection I219-LM

Technical Specifications – Networking

Intel® I219-V Gigabit Network Connection (Non-vPro configurations)

Ethernet Features

10 Mbit/s operation (10BASE-T; IEEE 802.3i; IEEE 802.3 clauses 13-14)
100 Mbit/s operation (10BASE-T; IEEE 802.3i; IEEE 802.3 clauses 13-14)
100 Mbit/s operation (100BASE-TX; IEEE 802.3u; IEEE 802.3 clauses 21-30)
1000 Mbit/s operation (1000BASE-T; IEEE 802.3ab; IEEE 802.3 Clauses 40)
Auto-Negotiation (Automatic Speed Selection)
Full Duplex Operation at all Speeds, Half Duplex operation at 10 and 100 Mbit/s
IEEE 802.1p QoS (Quality of Service) Support
IEEE 802.1q VLAN support
IEEE 802.3x Flow Control (IEEE 802.3 clauses 31-32; configurable)
IEEE 802.3az EEE(Energy Efficient Ethernet)
Jumbo Frame 9K
Auto MDI/MDIX Crossover cable detection

Power Management
ACPI compliant - multiple power modes
Energy Detect Low Power Mode(Green Ethernet)

Performance Features
TCP/IP/UDP Checksum Offload (configurable)
Protocol Offload(ARP & NS)
Large send offload and Giant send offload
Receiving Side Scaling
MACSec Offload (802.3ae)
Intel Non-vPro
iSCSI Boot

Manageability
Wake-on-LAN from standby and hibernation (Magic Packet and Microsoft Wake-Up Frame); Wake-on-LAN from off (Magic Packet only)
PXE 2.1 Remote Boot
Statistics Gathering (SNMP MIB II, Ethernet-like MIB, Ethernet MIB (802.3x, clause 30))
Comprehensive diagnostic and configuration software suite
Virtual Cable Doctor for Ethernet cable status

Interface
PCI Express 1.1 x1 to fully support ASPM L0s/L1 and CLKREQ.
NOTE: Intel® 82579 PCIe interface is not PCIe compliant. It operates at half of PCIe specification V1.1 (2.5GT/S) speed.

NIC Device Driver Name
Intel® 82579LM/82579V Ethernet Network Connection

Technical Specifications – Networking

HP It4132 LTE/HSPA+ 4G Mobile Broadband Module

Technology/Operating bands	LTE: 2100 (Band 1), 1900 (Band 2), 1800 (Band 3) MHz, 850 (Band 5), 2600 (Band 7), 900 (Band 8) MHz, 800 (Band 20), 700 (Band 28) MHz. HSPA+: 2100 (Band 1), 1900 (Band 2), 850 (Band 5), 900 (Band 8) MHz E-GPRS: 1900 (Band 2), 1800 (Band 3), 850 (Band 5), 900 (Band 8) MHz
Wireless protocol standards	3GPP Release 10 LTE Specification CAT.4, 20MHz BW WCDMA R99, 3GPP Release 5, 6, 7 and 8 UMTS Specification E-GPRS: Class B, Multi-slot class 12, coding schemes CS1 - CS4 and MSC1 - MSC9
GPS	Standalone, A-GPS (MS-B and LTO)
GPS bands	1575.42 MHz ± 1.023 MHz, GLONASS 1596-1607MHz
Maximum data rates	LTE: 150 Mbps (Download), 50 Mbps (Upload) DC-HSPA+: 42 Mbps (Download), 5.76 Mbps (Upload) HSPA+: 21Mbps (Download), 5.76 Mbps (Upload) EDGE: 236.8 kbps (Download), 236.8 kbps (Upload) GPRS: 85.6 kbps(Download), 85.6 kbps (Upload)
Maximum output power	LTE: 23 dBm HSPA+: 23.5 dBm E-GPRS 1900/1800: 26 dBm E-GPRS 900/850: 27 dBm GPRS 1900/1800: 29.5 dBm GPRS 900/850: 32.5 dBm
Maximum power consumption	LTE: 1,200 mA (peak); 900 mA (average) HSPA+: 1,100 mA (peak); 800 mA (average) E-GPRS: 2,600 mA (peak); 500 mA (average)
Form Factor	M.2, 3042-S3 Key B
Weight	6 g
Dimensions (Length x Width x Thickness)	42 x 30 x 2.3 mm

* Mobile Broadband is an optional feature. Connection requires wireless data service contract, network support, and is not available in all areas. Contact service provider to determine the coverage area and availability. Connection speeds will vary due to location, environment, network conditions, and other factors. 4G LTE not available on all products or in all countries.

Intel®XMM™ 7360 LTE-Advanced

Technology/Operating bands	FDD LTE: 2100 (Band 1), 1900 (Band 2), 1800 (Band 3), 1700/2100 (Band 4), 850 (Band 5), 2600 (Band 7), 900 (Band 8), 1400 (Band 11), 700 (Band 12 lower), 700 (Band 13 upper), 700 (Band 17 lower), 850 (Band 18 lower), 850 (Band 19 upper), 800 (Band 20), 1400 (Band 21), 850 (Band 26), 700 (Band 28), 700 (Band 29 RX only), 2300 (Band 30), 2100 (Band 66). TDD LTE: 2600 (Band 38), 1900 (Band 39), 2400 (Band 40), 2500 (Band 41). HSPA+: 2100 (Band 1), 1900 (Band 2), 1700/2100 (Band 4), 850(Band 5), 900 (Band 8)
Wireless protocol standards	3GPP Release 11 LTE Specification CAT.9, DL 60MHz BW throughput up to 450Mbps; UL 20MHz throughput up to 50Mbps WCDMA R99, 3GPP Release 5, 6, 7 and 8 UMTS Specification
GPS	Standalone, A-GPS (MS-A, MS-B and XTRA)
GPS Bands	1575.42 MHz ± 1.023 MHz, GLONASS 1596-1607MHz, Beidou 1561.098 MHz
Maximum Data Rates	LTE: 450Mbps (Download), 50Mbps (Upload) DC-HSPA+: 42Mbps (Download), 5.76Mbps (Upload) HSPA+: 21Mbps (Download), 5.76Mbps (Upload)

Technical Specifications – Networking

Maximum Output Power	LTE: 23dBm HSPA+: 23dBm
Maximum Power Consumption	LTE: 1,200mA (peak); 900mA (average) HSPA+: 1,100mA (peak); 800mA (average)
Form Factor	M.2, 3042-S3 Key B
Weight	5.8g
Dimensions (Length x Width x Thickness)	(42 x 30 x 2.3 mm)

Intel® Dual Band Wireless-AC 8265 802.11 AC/a/b/g/n (2x2) WiFi + Bluetooth® 4.2 Combo Adaptor* (vPro)	Wireless LAN Standards	IEEE 802.11a IEEE 802.11b IEEE 802.11g IEEE 802.11n IEEE 802.11n
	Interoperability	Wi-Fi certified
	Frequency Band	802.11b/g/n 2.402 - 2.482 GHz Note: The FCC has declared as of January 1, 2015 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels
		802.11a 4.9 - 4.95 GHz (Japan) 5.15 - 5.25 GHz 5.25 - 5.35 GHz 5.47 - 5.725 GHz 5.825 - 5.850 GHz Note: Indonesia only supports 5.725 - 5.825 GHz (CH149 - CH161)
	Data Rates	<ul style="list-style-type: none"> 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps 802.11b: 1, 2, 5.5, 11 Mbps 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps 802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz) 802.11ac : MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz, and 80MHz)
	Modulation	Direct Sequence Spread Spectrum CCK, BPSK, QPSK, 16-QAM, 64-QAM, 256-QAM
	Security¹	<ul style="list-style-type: none"> IEEE and Wi-Fi compliant 64 / 128 bit WEP encryption for a/b/g mode only AES-CCMP: 128 bit in hardware 802.1x authentication WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES. WPA2 certification IEEE 802.11i Cisco Certified Extensions, all versions through CCX4 and CCX Lite WAPI
	Network Architecture Models	Ad-hoc (Peer to Peer) Infrastructure (Access Point Required)
	Roaming	IEEE 802.11 compliant roaming between band Access Points

Technical Specifications – Networking

Output Power²	<ul style="list-style-type: none"> • 802.11b : +16dBm minimum • 802.11g : +14dBm minimum • 802.11a : +14dBm minimum • 802.11n HT20(2.4GHz) : +13dBm minimum • 802.11n HT40(2.4GHz) : +13dBm minimum • 802.11n HT20(5GHz) : +12dBm minimum • 802.11n HT40(5GHz) : +12dBm minimum 				
Power Consumption	<p>Transmit: 2.0 Watts (max) Receive: 1.6 Watts (max) Idle mode (PSP): 180 mW (WLAN Associated) Idle mode: 50 mW (WLAN unassociated) Connect Standby: 10mW (WLAN + BT) Radio disabled: 5 mW</p>				
Power Management	<p>ACPI and PCI Express compliant power management 802.11 compliant power saving mode</p>				
Receiver Sensitivity³	<p>802.11b, 1Mbps : -94dBm maximum 802.11b, 11Mbps : -86dBm maximum 802.11g, 6Mbps : -88dBm maximum 802.11g, 54Mbps : -74dBm maximum 802.11a, 6Mbps : -88dBm maximum 802.11a, 54Mbps : -74dBm maximum 802.11n, MCS07 : -69dBm maximum 802.11n, MCS15 : -66dBm maximum 802.11ac, 1SS, MCS-0 : -86dBm maximum 802.11ac, 1SS, MCS-9 : -61dBm maximum 802.11ac, 2SS, MCS-0 : -83dBm maximum 802.11ac, 2SS, MCS-9 : -58dBm maximum</p>				
Antenna Type	<p>High efficiency antenna with spatial diversity, mounted in the display enclosure Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO and Bluetooth communications</p>				
Form Factor	<p>PCI-Express M.2 MiniCard</p>				
Dimensions	<p>Type 2230 : 2.3 x 22.0 x 30.0 mm Or Type 1630 : 2.3 x 16.0 x 30.0 mm</p>				
Weight	<p>Type 2230 : 2.8g Or Type 1630 : 2g</p>				
Operating Voltage	<p>3.3v +/- 9%</p>				
Temperature	<table border="0"> <tr> <td>Operating</td> <td>14° to 158° F (-10° to 70° C)</td> </tr> <tr> <td>Non-operating</td> <td>-40° to 176° F (-40° to 80° C)</td> </tr> </table>	Operating	14° to 158° F (-10° to 70° C)	Non-operating	-40° to 176° F (-40° to 80° C)
Operating	14° to 158° F (-10° to 70° C)				
Non-operating	-40° to 176° F (-40° to 80° C)				
Humidity	<table border="0"> <tr> <td>Operating</td> <td>10% to 90% (non-condensing)</td> </tr> <tr> <td>Non-operating</td> <td>5% to 95% (non-condensing)</td> </tr> </table>	Operating	10% to 90% (non-condensing)	Non-operating	5% to 95% (non-condensing)
Operating	10% to 90% (non-condensing)				
Non-operating	5% to 95% (non-condensing)				
Altitude	<table border="0"> <tr> <td>Operating</td> <td>0 to 10,000 ft (3,048 m)</td> </tr> <tr> <td>Non-operating</td> <td>0 to 50,000 ft (15,240 m)</td> </tr> </table>	Operating	0 to 10,000 ft (3,048 m)	Non-operating	0 to 50,000 ft (15,240 m)
Operating	0 to 10,000 ft (3,048 m)				
Non-operating	0 to 50,000 ft (15,240 m)				
LED Activity	<p>LED Amber – Radio OFF; LED White – Radio ON</p>				

**Intel® Dual Band
 Wireless-AC 8265 802.11
 AC/a/b/g/n (2x2) WiFi +**

Wireless LAN Standards

IEEE 802.11a
 IEEE 802.11b
 IEEE 802.11g



Technical Specifications – Networking

Bluetooth® 4.2 Combo Adaptor* (non-vPro)

Interoperability

IEEE 802.11n
IEEE 802.11ac
Wi-Fi certified

Frequency Band

802.11b/g/n

2.402 - 2.482 GHz

Note: The FCC has declared as of January 1, 2015 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels

802.11a

- 4.9 - 4.95 GHz (Japan)
- 5.15 - 5.25 GHz
- 5.25 - 5.35 GHz
- 5.47 - 5.725 GHz
- 5.825 - 5.850 GHz

Note: Indonesia only supports 5.725 - 5.825 GHz (CH149 - CH161)

Antenna Structure

2 transmit; 2 receive (2x2)

Data Rates

802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps

802.11b: 1, 2, 5.5, 11 Mbps

802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps

802.11n: card will support rates for NSS=1 and NSS=2 for RX and TX for 20 and 40 MHz channels. Short and long guard interval shall be supported.

802.11ac : MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz, and 80MHz)

Modulation

Direct Sequence Spread Spectrum

BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM

Security¹

- IEEE and Wi-Fi compliant 64 / 128 bit WEP encryption for a/b/g mode only
- AES-CCMP: 128 bit in hardware
- 802.1x authentication
- WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.
- WPA2 certification
- IEEE 802.11i
- Cisco Certified Extensions, all versions through CCX4 and CCX Lite
- WAPI

Network Architecture

Ad-hoc (Peer to Peer)

Models

Infrastructure (Access Point Required)

Roaming

IEEE 802.11 compliant roaming between access points

Output Power²

- 802.11b : +16dBm minimum
- 802.11g : +14dBm minimum
- 802.11a : +14dBm minimum
- 802.11n HT20(2.4GHz) : +13dBm minimum
- 802.11n HT40(2.4GHz) : +13dBm minimum
- 802.11n HT20(5GHz) : +12dBm minimum
- 802.11n HT40(5GHz) : +12dBm minimum

802.11ac 80MHz(5GHz) : +11dBm minimum

Technical Specifications – Networking

Power Consumption	Transmit: 2.0 W (max) Receive: 1.6 W (max) Idle mode (PSP): 180 mW (WLAN Associated) Idle mode: 60 mW (WLAN unassociated) Radio disabled: 30 mW
Power Management	ACPI and PCI Express compliant power management 802.11 compliant power saving mode
Receiver Sensitivity³	802.11g:-90 dBm (6 Mbps), -89 dBm (9 Mbps), -87 dBm (12 Mbps), -85 dBm (18 Mbps), -82 dBm (24 Mbps), -79 dBm (36 Mbps), -76 dBm (48 Mbps), -74 dBm (54 Mbps) 802.11b:-95 dBm (1 Mbps), -93 dBm (2 Mbps), -91 dBm (5.5 Mbps), -88 dBm (11 Mbps) 802.11g:-90 dBm (6 Mbps), -89 dBm (9 Mbps), -87 dBm (12 Mbps), -85 dBm (18 Mbps), -82 dBm (24 Mbps), -79 dBm (36 Mbps), -76 dBm (48 Mbps), -74 dBm (54 Mbps) 802.11n:-69 dBm (150 Mbps), -66 dBm (300 Mbps)
Antenna type	High efficiency antenna with spatial diversity, mounted in the display enclosure Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications
Form Factor	PCI-Express Half-MiniCard
Dimensions	0.134 x 1.06 x 1.18 in (3.4 x 26.8 x 30 mm)
Weight	3.1 g
Operating Voltage	3.3v +/- 9%
Temperature	Operating 14° to 158° F (-10° to 70° C) Non-operating -40° to 176° F (-40° to 80° C)
Humidity	Operating 10% to 90% (non-condensing) Non-operating 5% to 95% (non-condensing)
Altitude	Operating 0 to 10,000 ft. (3,048 m) Non-operating 0 to 50,000 ft. (15,240 m)
LED Activity	LED Amber - Radio OFF; LED White - Radio ON

1. Check latest software/driver release for updates on supported security features.
2. Maximum output power may vary by country according to local regulations.
3. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

Technical Specifications – Networking

Realtek RTL8822BE
802.11ac 2x2 Wi-Fi +
BT4.2 Combo Adapter

Wireless LAN Standards

IEEE 802.11a
 IEEE 802.11b
 IEEE 802.11g
 IEEE 802.11n
 IEEE 802.11ac

Interoperability
Frequency Band

Wi-Fi certified
 802.11b/g/n

2.402 - 2.482 GHz

Note: The FCC has declared as of January 1, 2015 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels

802.11a

- 4.9 - 4.95 GHz (Japan)
- 5.15 - 5.25 GHz
- 5.25 - 5.35 GHz
- 5.47 - 5.725 GHz
- 5.825 - 5.850 GHz

Note: Indonesia only supports 5.725 - 5.825 GHz (CH149 - CH161)

Data Rates

802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
 802.11b: 1, 2, 5.5, 11 Mbps
 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
 802.11n: card will support rates for NSS=1 and NSS=2 for RX and TX for 20 and 40 MHz channels. Short and long guard interval shall be supported.
 802.11ac : MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz, and 80MHz)

Modulation

Direct Sequence Spread Spectrum
 BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM

Security¹

- IEEE and Wi-Fi compliant 64 / 128 bit WEP encryption for a/b/g mode only
- AES-CCMP: 128 bit in hardware
- 802.1x authentication
- WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.
- WPA2 certification
- IEEE 802.11i
- Cisco Certified Extensions, all versions through CCX4 and CCX Lite
- WAPI

Network Architecture Models

Ad-hoc (Peer to Peer)
 Infrastructure (Access Point Required)

Roaming

IEEE 802.11 compliant roaming between access points

Output Power²

TX Power(dBm)	Min	Typical	Max
802.11b	+14	+15.5	
802.11g	+12	+13.5	

Technical Specifications – Networking

802.11a	+12	+13.5	
802.11n HT20(2.4GHz)	+12	+13.5	
802.11n HT40(2.4GHz)	+12	+13.5	
802.11n HT20(5GHz)	+10	+11.5	
802.11n HT40(5GHz)	+10	+11.5	
802.11ac VHT80(5GHz)	+10	+11.5	

Power Consumption

Transmit: 2.0 W (max)
 Receive: 1.6 W (max)
 Idle mode (PSP): 180 mW (WLAN Associated)
 Idle mode: 50 mW (WLAN unassociated)
 Connect Standby: 10 mW (WLAN+BT)
 Radio disabled: 8 mW

Power Management

ACPI and PCI Express compliant power management
 802.11 compliant power saving mode

Receiver Sensitivity³

RX Sensitivity(dBm)	Min	Typical	Max
802.11b, 1Mbps		-95	-93.5
802.11b, 11Mbps		-85.5	-84
802.11a/g, 6Mbps		-87.5	-86
802.11a/g, 54Mbps		-73.5	-72
802.11n, MCS07		-68.5	-67
802.11n, MCS15		-65.5	-64
802.11ac, MCS0		-85.5	-84
802.11ac, MCS9		-60.5	-59

Antenna type

High efficiency antenna with spatial diversity, mounted in the display enclosure
 Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications

Form Factor

PCI-Express M.2 MiniCard

Dimensions

Type 2230 : 2.3 x 22.0 x 30.0 mm

Or

Type 1630 : 2.3 x 16.0 x 30.0 mm

Weight

Type 2230 : 2.8g

Or

Type 1630 : 2g

Operating Voltage

3.3v +/- 9%

Temperature

Operating 14° to 158° F (–10° to 70° C)
 Non-operating –40° to 176° F (–40° to 80° C)

Humidity

Operating 10% to 90% (non-condensing)
 Non-operating 5% to 95% (non-condensing)

Altitude

Operating 0 to 10,000 ft (3,048 m)
 Non-operating 0 to 50,000 ft (15,240 m)

LED Activity

LED Amber - Radio OFF; LED White - Radio ON

1. Check latest software/driver release for updates on supported security features.
2. Maximum output power may vary by country according to local regulations.

Technical Specifications – Networking

3. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

Near Field Communications (NFC)

Controller	NFC Mirage WNC XRAV-1 (NXP NPC300 I2C 10mmx17mm)	
Supports	<ul style="list-style-type: none"> • Windows 10 • NFC Forum Compliant • Near Field Communications Controller 	
Dimensions (L x W x H)	Module 25 mm by 10 mm by 2.0 mm	
Chipset	NPC300	
System interface	I2C	
NFC RF standards	Standards ISO/IEC 14443 A ISO/IEC 14443 B ISO/IEC 15693 ISO/IEC 18092 ECMA-340 NFCIP-1 Target and Initiator ECMA-320 NFCIP-2	
NFC Forum Support Tag	Type 1, Type 2, Type3 and Type 4, NFCIP-1 and NFCIP-2	
Reader	(PCD-VCD) Mode(1) ISO/IEC 14443 A ISO/IEC 14443 B ISO/IEC 15693 MIFARE 1K MIFARE 4K MIFARE DESFire FeliCa Jewel and Topaz cards	
Card Emulation	(PICC-VICC)	
Mode¹	ISO/IEC 14443 A ISO/IEC 14443 B and B' MIFARE FeliCa	
Frequency	13.56 MHz	
NFC Modes Supported	Reader/Writer, Peer-to-Peer	
Raw RF Data Rates	106, 212, 424, 848 kbps	
Operating temperature	0°C to 70°C	
Storage temperature	-20°C to 125°C	
Humidity	10-90% operating 5-95% non-operating	
Supply Operating voltage	2.97 to 5.5 Volts	
I/O Voltage	1.8V or 3.3V	
Power Consumption	Booster enable,	VBAT= 3.3V,
	VCC_BOOST = 5V)	Typical ² Polling 7.3 mA Detected Test Tag Type 1 Total
	Mode Power	283.8 mA Net Module 236.8 mA Detected Test Tag Type
	Consumption,	2 Total 288.8 mA Net Module 241.8 mA Detected Test
		Tag Type 3 Total 287.7 mA Net Module 240.7 mA
		Detected Test Tag Type 4 Total 282.3 mA Net Module
		235.3 mA
Antenna connector	0.5mm pitch, 7 connector FPC. Antenna matching is external to module.	

- Notes**
1. With application or UICC support
 2. Actual Power Consumption is dependent on NFC antenna and matching circuit and on the particular polling sequence and period configured.

Technical Specifications – Audio

AUDIO/MULTIMEDIA – BANG & OLUFSEN

Hardware	Implementation	Conexant CX7750
	Function Key	Volume up, volume down, and mute
	Volume Controls	
	Line In/Line Out	Yes, via dock
	Headphone/Microphone in	Yes combo jack
	Integrated Microphone	Yes, Tri digital microphone array when equipped with optional webcam

Audio Output Quality	Frequency Response	20 Hz - 20 kHz
	Signal to Noise Ratio	104 dB
	Total Harmonic Distortion+noise @ -3dBFS	-90dBFS
	Noise Floor	-110 dB
	DAC	195kHz
	ADC	96kHz

Integrated Stereo Speakers	Power Rating	2 Watts
	Impedance	4 Ohms

Technical Specifications – Power

POWER

HP 65W Smart AC Adapter	Dimensions	107.0x47.0x30.0mm	
	Weight	unit: 250g +/- 10g	
	Input	90 to 265 VAC	
		Input Efficiency	88.0 % at 115 Vac and 89.0 % at 230 Vac
		Input frequency range	47 to 63 Hz
		Input AC current	Max 1.7 A at 90 Vac
	Output	Output power	65W
		DC output	19.5V
		Hold-up time	5 ms at 115 Vac input
		Output current limit	<11.0A
	AC Connector (Ac Inlet)	C6 (3pin/with grounded, with Smart ID DC connector)	
	AC Connector (Ac Inlet)	Operating temperature	32° to 95° F (0° to 35° C)
	Environmental Design	Non-operating (storage) temperature	-4° to 185° F (-20° to 85° C)
		Altitude	0 to 16,400 ft (0 to 5,000 m)
		Humidity	20% to 95%
	Storage Humidity	10% to 95%	
EMI and Safety Certifications	<p>*CE Mark - full compliance with LVD and EMC directives</p> <p>* Worldwide safety standards - IEC60950, EN60950, UL60950, Class 1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE.</p> <p>* MTBF - over 200,000 hours at 25°C ambient condition.</p>		

HP 65W Smart AC Adapter EM	Dimensions	102.0x55.0x30.0mm	
	Weight	unit: 350g +/- 10g	
	Input	90 to 265 VAC	
		Input Efficiency	87.0% min at 115 VAC and 230Vac
		Input frequency range	47 to 63 Hz
		Input AC current	Max. 1.7 A at 90 VAC
	Output	Output power	65W
		DC output	19.5V
		Hold-up time	5 ms at 115 Vac input
		Output current limit	<11.0A
	AC Connector (Ac Inlet)	C6 (3pin/with grounded, with Smart ID DC connector)	
	AC Connector (Ac Inlet)	Operating temperature	32° to 95° F (0° to 35° C)
	Environmental Design		

Technical Specifications – Power

Non-operating (storage) temperature	-4° to 185° F (-20° to 85° C)
Altitude	0 to 16,400 ft (0 to 5,000 m)
Humidity	20% to 95%
Storage Humidity	10% to 95%

EMI and Safety Certifications *CE Mark - full compliance with LVD and EMC directives
 * Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE.
 * MTBF - over 200,000 hours at 25°C ambient condition.

HP 65W Travel AC Adapter

Dimensions	120.0x57.6x16.7mm
Weight	unit: 250g +/- 10g
Input	Input Efficiency 88.0 % at 115 Vac and 89.0 % at 230Vac Input frequency range 47 to 63 Hz Input AC current 1.7 A at 90 Vac
Output	Output power 65W DC output 19.5V/5V Hold-up time 5 ms at 115 Vac input Output current limit <11.0A
DC Plug	4.5mm/7.4mm tips
Environmental Design	Operating temperature 32° to 95° F (0° to 35° C) Non-operating (storage) temperature -4° to 185° F (-20° to 85° C) Altitude 0 to 16,400 ft (0 to 5,000 m) Humidity 20% to 95% Storage Humidity 10% to 95%
EMI and Safety Certifications	*CE Mark - full compliance with LVD and EMC directives * Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE. * MTBF - over 200,000 hours at 25°C ambient condition.

HP 45W Smart AC Right Angle Adapter Argentina

Dimensions	3.74 x 1.57 x 1.04 in (9.5 x 4.0 x 2.65 cm)
Weight	0.386 lb (175g) max
Input	Input Efficiency 87.74% at 115Vac and 88.4% at 230Vac Input frequency range 47 to 63 Hz Input AC current Max 1.4 A at 90 VAC
Output	Output power 45W DC output 19.5V

QuickSpecs

HP ZBook 14u G5 Mobile Workstation

Options and Accessories (sold separately and availability may vary by country)

	Environmental Design	Hold-up time	5 ms at 115 Vac input
		Output current limit	<8.0 A
		Operating temperature	32° to 95° F (0° to 35° C)
		Non-operating (storage) temperature	-4° to 185° F (-20° to 85° C)
		Altitude	0 to 16,400 ft (0 to 5,000 m)
		Humidity	5% to 95%
		Storage Humidity	5% to 95%
	EMI and Safety Certifications	*CE Mark - full compliance with LVD and EMC directives * Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE.	
		* MTBF - over 200,000 hours at 25°C ambient condition.	
HP 65W Smart AC Adapter Argentina	Dimensions	107.0x47.0x30.0mm	
	Weight	unit: 250g +/- 10g	
	Input	90 to 265 VAC	
		Input Efficiency	88.0 % at 115 Vac and 89.0 % at 230 Vac
		Input frequency range	47 to 63 Hz
		Input AC current	Max 1.7 A at 90 Vac
	Output	Output power	65W
		DC output	19.5V
		Hold-up time	5 ms at 115 Vac input
		Output current limit	<11.0A
	AC Connector (Ac Inlet)	C6 (3pin/with grounded, with Smart ID DC connector)	
	AC Connector (Ac Inlet) Environmental Design	Operating temperature	32° to 95° F (0° to 35° C)
		Non-operating (storage) temperature	-4° to 185° F (-20° to 85° C)
		Altitude	0 to 16,400 ft (0 to 5,000 m)
		Humidity	20% to 95%
		Storage Humidity	10% to 95%
	EMI and Safety Certifications	*CE Mark - full compliance with LVD and EMC directives * Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE. * MTBF - over 200,000 hours at 25°C ambient condition.	
HP 65W Travel AC Adapter	Dimensions	120.0x57.6x16.7mm	
	Weight	unit: 250g +/- 10g	
	Input	Input Efficiency	88.0 % at 115 Vac and 89.0 % at 230Vac

Options and Accessories (sold separately and availability may vary by country)

	Input frequency range	47 to 63 Hz
	Input AC current	1.7 A at 90 Vac
Output	Output power	65W
	DC output	19.5V/5V
	Hold-up time	5 ms at 115 Vac input
	Output current limit	<11.0A
DC Plug	4.5mm/7.4mm tips	
Environmental Design	Operating temperature	32° to 95° F (0° to 35° C)
	Non-operating (storage) temperature	-4° to 185° F (-20° to 85° C)
	Altitude	0 to 16,400 ft (0 to 5,000 m)
	Humidity	20% to 95%
	Storage Humidity	10% to 95%
EMI and Safety Certifications	<p>*CE Mark - full compliance with LVD and EMC directives</p> <p>* Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE.</p> <p>* MTBF - over 200,000 hours at 25°C ambient condition.</p>	
HP 45W Smart AC Right Angle Adapter Argentina	Dimensions	3.74 x 1.57 x 1.04 in (9.5 x 4.0 x 2.65 cm)
	Weight	0.386 lb (175g) max
	Input	<p>Input Efficiency 87.74% at 115Vac and 88.4% at 230Vac</p> <p>Input frequency range 47 to 63 Hz</p> <p>Input AC current Max 1.4 A at 90 VAC</p>
	Output	<p>Output power 45W</p> <p>DC output 19.5V</p> <p>Hold-up time 5 ms at 115 Vac input</p> <p>Output current limit <8.0 A</p>
	Environmental Design	<p>Operating temperature 32° to 95° F (0° to 35° C)</p> <p>Non-operating (storage) temperature -4° to 185° F (-20° to 85° C)</p> <p>Altitude 0 to 16,400 ft (0 to 5,000 m)</p> <p>Humidity 5% to 95%</p> <p>Storage Humidity 5% to 95%</p>

Options and Accessories (sold separately and availability may vary by country)

	EMI and Safety Certifications	<ul style="list-style-type: none"> *CE Mark - full compliance with LVD and EMC directives * Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE. * MTBF - over 200,000 hours at 25°C ambient condition.
HP 45W Smart AC Right Angle Adapter	Dimensions	3.74 x 1.57 x 1.04 in (9.5 x 4.0 x 2.65 cm)
	Weight	0.386 lb (175g) max
	Input	<ul style="list-style-type: none"> Input Efficiency 87.74% at 115Vac and 88.4% at 230Vac Input frequency range 47 to 63 Hz Input AC current Max 1.4 A at 90 VAC
	Output	<ul style="list-style-type: none"> Output power 45W DC output 19.5V Hold-up time 5 ms at 115 Vac input Output current limit <8.0 A
	Environmental Design	<ul style="list-style-type: none"> Operating temperature 32° to 95° F (0° to 35° C) Non-operating (storage) temperature -4° to 185° F (-20° to 85° C) Altitude 0 to 16,400 ft (0 to 5,000 m) Humidity 5% to 95% Storage Humidity 5% to 95%
	EMI and Safety Certifications	<ul style="list-style-type: none"> *CE Mark - full compliance with LVD and EMC directives * Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE. * MTBF - over 200,000 hours at 25°C ambient condition.
HP 45W Smart AC Adapter (2 Prong)	Dimensions (H x W x D)	95.0x40.0x26.5mm
	Weight	unit: 200g +/- 10g
	Input	<ul style="list-style-type: none"> 90 to 265 VAC Input Efficiency 87.74% at 115Vac and 88.4% at 230Vac Input frequency range 47 to 63 Hz Input AC current Max. 1.4 A at 90 Vac
	Output	<ul style="list-style-type: none"> Output power 45W DC output 19.5V Hold-up time 5 ms at 115 Vac input Output current limit <8.0A
	AC Connector (Ac Inlet)	C8 (2 pin/non-grounded, with Smart ID DC connector)
	Environmental Design	<ul style="list-style-type: none"> Operating temperature 32° to 95° F (0° to 35° C) Non-operating (storage) temperature -4° to 185° F (-20° to 85° C) Altitude 0 to 16,400 ft (0 to 5,000 m) Humidity 20% to 95%

Options and Accessories (sold separately and availability may vary by country)

	EMI and Safety Certifications	Storage Humidity 10% to 95% *CE Mark - full compliance with LVD and EMC directives * Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE. * MTBF - over 200,000 hours at 25°C ambient condition.
HP 45W Smart USB Type C Adapter	Dimensions	62.0x62.0x28.5mm
	Weight	unit: 220g +/- 10g
	Input	Input Efficiency Average Efficiency of 25%, 50%, 75%, 100% load condition with 115Vac/230Vac Spec:
		5V : 81.5% 9V : 86.7% 10V : 87.5% 12V : 87.8% 15V : 87.8% 20V : 87.8%
		Input frequency range 47 to 63 Hz
		Input AC current Max 1.4 A at 90 Vac
	Output	Output power 45W
		DC output 5V/15W; 9V/27W; 10V/37.5W; 12V/45W; 15V/45W; 20V/45W
		Hold-up time 5 ms at 115 Vac input
		Output current limit <5.0A
	Environmental Design	Operating temperature 32° to 95° F (0° to 35° C)
		Non-operating (storage) temperature -4° to 185° F (-20° to 85° C)
		Altitude 0 to 16,400 ft (0 to 5,000 m)
		Humidity 5% to 95%
		Storage Humidity 5% to 95%
	EMI and Safety Certifications	*CE Mark - full compliance with LVD and EMC directives * Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE. * MTBF - over 200,000 hours at 25°C ambient condition.

Options and Accessories (sold separately and availability may vary by country)

HP Long Life 3-cell Polymer Battery (50Whr)	Dimensions (H x W x L)	7.1mm x 76.3mm x 278.7mm	
	Weight	193 g +/- 10g	
	Cells/Type	3cell Lithium-Ion Polymer cell / P604883A1	
	Energy	Voltage	11.55V
		Amp-hour capacity	4.113Ah/4.330Ah
		Watt-hour capacity	50whr
	Temperature	Operating (Charging)	32° to 122° F (0° to 50° C)
		Operating (Discharging)	14° to 140° F (-10° to 60° C)
	Fuel Gauge LED	No	
	Warranty	3-years	
	Optional Travel Battery Available	No	

Options and Accessories (sold separately and availability may vary by country)

ENVIRONMENTAL DATA

Eco-Label Certifications & declarations

This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks:

- IT ECO declaration
- US ENERGY STAR®
- EPEAT[®] Gold registered in the United States. See <http://www.epeat.net> for registration status in your country. Search keyword *generator* on HP's 3rd party option store for solar energy accessory at <http://www.hp.com/go/options>.

System Configuration

The configuration used for the Energy Consumption and Declared Noise Emissions data for the Notebook model is based on a "Typically Configured Notebook".

Energy Consumption (in accordance with US ENERGY STAR® test method)

	115VAC, 60Hz	230VAC, 50Hz	100VAC, 60Hz
Normal Operation (Short idle)	9.06 W	9.98 W	9.6 W
Normal Operation (Long idle)	7.31 W	7.82 W	8.0 W
Sleep	0.76 W	0.89 W	0.75 W
Off	0.44 W	0.56 W	0.43 W

NOTE:

Energy efficiency data listed is for an ENERGY STAR® compliant product if offered within the model family. HP computers marked with the ENERGY STAR® Logo are compliant with the applicable U.S. Environmental Protection Agency (EPA) ENERGY STAR® specifications for computers. If a model family does not offer ENERGY STAR® compliant configurations, then energy efficiency data listed is for a typically configured PC featuring a hard disk drive, a high efficiency power supply, and a Microsoft Windows® operating system.

Heat Dissipation*

	115VAC, 60Hz	230VAC, 50Hz	100VAC, 60Hz
Normal Operation (Short idle)	31 BTU/hr	34 BTU/hr	33 BTU/hr
Normal Operation (Long idle)	25 BTU/hr	27 BTU/hr	27 BTU/hr
Sleep	3 BTU/hr	3 BTU/hr	3 BTU/hr
Off	2 BTU/hr	2 BTU/hr	1 BTU/hr

*NOTE: Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour.

Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296)

	Sound Power (L _{WAd} , bels)	Sound Pressure (L _{pAm} , decibels)
Typically Configured – Idle	2.9	20
Fixed Disk – Random writes	2.9	21

Longevity and Upgrading

This product can be upgraded, possibly extending its useful life by several years. Upgradeable features and/or components contained in the product may include:

Spare parts are available throughout the warranty period and or for up to "5" years after the end of production.

Batteries

This battery(s) in this product comply with EU Directive 2006/66/EC

Batteries used in the product do not contain:

Options and Accessories (sold separately and availability may vary by country)

Mercury greater than 1ppm by weight
Cadmium greater than 20ppm by weight

Battery description: CR2032 (coin cell)
Battery type: Lithium

Additional Information

- This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive - 2011/65/EC.
- This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive – 2002/96/EC.
- This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986).
- This product is in compliance with the IEEE 1680 (EPEAT) standard at the gold level, see www.epeat.net
- Plastics parts weighing over 25 grams used in the product are marked per ISO11469 and ISO1043.
- This product contains 7.8% post-consumer recycled plastic (by wt.)
- This product is 96.1% recycle-able when properly disposed of at end of life.

Packaging Materials

External:	PAPER/Cardboard & misc	360.2 g
Internal:	PLASTIC/EPE (Expanded Polyethylene)	29.8 g
	PLASTIC/Polyethylene low density	13.6 g
	PLASTIC/Polypropylene	6 g

The plastic packaging material contains at least 50% recycled content.

The corrugated paper packaging materials contains at least 70% recycled content.

Material Usage

This product does not contain any of the following substances in excess of regulatory limits (refer to the HP General Specification for the Environment at <http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/gse.pdf>):

- Asbestos
- Certain Azo Colorants
- Certain Brominated Flame Retardants – may not be used as flame retardants in plastics
- Cadmium
- Chlorinated Hydrocarbons
- Chlorinated Paraffins
- Formaldehyde
- Halogenated Diphenyl Methanes
- Lead carbonates and sulfates
- Lead and Lead compounds
- Mercuric Oxide Batteries
- Nickel – finishes must not be used on the external surface designed to be frequently handled or carried by the user.
- Ozone Depleting Substances
- Polybrominated Biphenyls (PBBs)
- Polybrominated Biphenyl Ethers (PBBEs)
- Polybrominated Biphenyl Oxides (PBBOs)
- Polychlorinated Biphenyl (PCB)
- Polychlorinated Terphenyls (PCT)
- Polyvinyl Chloride (PVC) – except for wires and cables, has been voluntarily removed from most applications.
- Radioactive Substances

Options and Accessories (sold separately and availability may vary by country)

- Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)

Packaging Usage

HP follows these guidelines to decrease the environmental impact of product packaging:

- Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging materials.
- Eliminate the use of ozone-depleting substances (ODS) in packaging materials.
- Design packaging materials for ease of disassembly.
- Maximize the use of post-consumer recycled content materials in packaging materials.
- Use readily recyclable packaging materials such as paper and corrugated materials.
- Reduce size and weight of packages to improve transportation fuel efficiency.
- Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.

End-of-life Management and Recycling

Hewlett-Packard offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: <http://www.hp.com/go/reuse-recycle> or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner.

The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This information (product disassembly instructions) is posted on the Hewlett Packard web site at: <http://www.hp.com/go/recyclers>. These instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM customers who integrate and re-sell HP equipment.

HP Inc. Corporate Environmental Information

For more information about HP's commitment to the environment:

Global Citizenship Report

<http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html>

Eco-label certifications

<http://www8.hp.com/us/en/hp-information/environment/ecolabels.html>

ISO 14001 certificates:

<http://h20195.www2.hp.com/V2/GetDocument.aspx?docname=c04755842>

and

<http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/cert.pdf>

Country of Origin

China

Type	Description	Part #
Memory	HP 4GB DDR4-2400 SODIMM (Core processors only)	Z4Y84AA
	HP 16GB DDR4-2400 SODIMM (Core processors only)	Z4Y86AA
Cases	HP 15.6 Business Top Load– Refresh	2SC66AA
Docking	HP USB-C Universal Dock	1MK33AA#xxx
	HP USB-C Mini Dock	1PM64AA#xxx
	HP USB-C Universal Dock w/4.5mm Adapter	2UF95AA

Options and Accessories (sold separately and availability may vary by country)

	HP Thunderbolt Dock 120W G2	2UK37AA
	HP Thunderbolt Dock 120W G2 TAA	2UK37AA
	HP TB Dock G2 w/Combo Cable	3TR87AA#xxx
	HP TB Docks 120W G2 w/Audio	3YE87AA#xxx
	HP Ultra Slim Docking Station	D9Y32AA#xxx
	HP Travel Hub	T0K30AA
Input/Output - Mice	HP Comfort Grip Mouse	H2L63AA
	HP 3-Button Laser Mouse	H4B81AA#xxx
	HP X4000 Bluetooth Mouse	H3T50AA#xxx
	HP Slim Bluetooth Mouse	F3J92AA#xxx
	HP USB Travel Mouse	G1K28AA#xxx
	HP Slim Wireless Keyboard and Mouse	T6L04AA#xxx
	HP Slim USB Keyboard and Mouse	T6T83AA
	HP Wireless (Link-5) Keyboard	T6U20AA#xxx
	HP 65W Smart AC Adapter	H6Y89AA
	HP 90W Smart AC Adapter	H6Y90AA
	HP 150W Slim Smart AC Adapter	TBD
Battery	HP TA03XL Rechargeable Battery	1FN06AA
Adapters	HP USB-C™ to VGA Adapter	N9K76AA
	HP USB-C to USB Hub	Z6A00AA
	HP HDMI to DVI adapter	F5A28AA
	DisplayPort™ to DVI Adapter	F7W96AA
	DisplayPort™ to VGA	F7W97AA
	DisplayPort™ to HDMI 1.4 Adapter	F3W43AA
Wireless	HP lt4120 LTE/EVDO/HSPA+ Gobi™ 4G Mobile Broadband Module	TBD
Collaboration	HP UC Conferencing Keyboard	K8P74AA#xxx
	HP USB Collaboration Keyboard	Z9N38AA
	HP Stereo 3.5mm Headset	T1A66AA
	HP Stereo USB Headset	T1A67AA
Storage - External Storage	HP External USB DVDRW Drive	F2B56AA
	HP 500GB 7200rpm HDD	F3B97AA
	HP 256GB M2 NVME PCIe SSD (2280)	V3K66AA
	HP 512GB M2 NVME PCIe SSD (2280)	V3K67AA
Security	HP Dual Head Cable Lock (Non-Master key)	T1A64AA
	HP Dual Head Cable Lock (Master Key)	T1A65AA
	HP 15.6" Notebook PC Privacy Filter (non-touch)	J7H71AA
	HP Docking Station Cable Lock	AU656AA#XXX

Options and Accessories (sold separately and availability may vary by country)

	HP Essential Combination Lock	TOY16AA
	HP Combination Lock	TOY15AA
	HP Keyed Cable Lock	TOY14AA
Care Packs	(for 1 year platforms)	UC282E
	(for 3 year platforms)	UC279E

NOTE: External power supplies, power cords, cables and peripherals are not low halogen. Service parts obtained after purchase may not be low halogen.

Copyright © 2019 HP Development Company, L.P. The information contained herein is subject to change without notice. The only warranties for HP products are set forth in the express limited warranty statements accompanying such products. Nothing herein should be construed as constituting an additional warranty. HP shall not be liable for technical or editorial errors or omissions contained herein.

Intel, Core, and Celeron, Thunderbolt and vPro are registered trademarks or trademarks of Intel Corporation or its subsidiaries in the U.S. and/or other countries. Bluetooth is a registered trademark of its proprietor used by HP Inc. under license. AMD, FirePro, and Enduro are trademarks of Advanced Micro Devices, Inc. Adobe is a trademark of Adobe Systems Incorporated. Microsoft and Windows are U.S. registered trademarks of Microsoft Corporation in the United States and/or other countries. Qualcomm and Snapdragon are trademarks of Qualcomm, Inc. SD, SDHC, and SDXC are trademarks or registered trademarks of SD-3C in the United States, other countries or both. USB Type-C and USB-C are trademarks of USB Implementers Forum. ENERGY STAR® is a registered trademark mark of the U.S. Environmental Protection Agency.

Date of change:	Version History:		Description of change:
February 15, 2018	From v1 to v2	Changed	Environmental data updated
February 23, 2018	From v2 to v3	Added	Dock, case, mouse, adapter, display and care packs added to options section
March 1, 2018	From v3 to v4	Added	Battery note on power supply section
August 22, 2018	From v4 to v5	Changed	General update
August 27, 2018	From v5 to v6	Changed	Format
October 17, 2018	From v6 to v7	Changed	Format
January 23, 2019	From v7 to v8	Changed	Format